



Customer Information Notification

202004014I

Issue Date: 24-Apr-2020

Effective Date: 25-May-2020

Here's your personalized quality information concerning products Digi-Key purchased from NXP. For detailed information we invite you to view this notification online

This notice is NXP Company Proprietary.



QUALITY

Change Category

☐ Wafer Fab Process

☐ Assembly Process

☐ Product Marking

☒ Test Location

☐ Design

☐ Wafer Fab Materials

☐ Assembly Materials

☐ Mechanical Specification

☐ Test Process

☐ Errata

☐ Wafer Fab Location

☐ Assembly Location

☐ Packing/Shipping/Labeling Equipment

☐ Test

☐ Electrical spec./Test coverage

☐ Firmware

☐ Other

i.MXRT1050 / RT1060 /
RT106A / RT1064 10x10
196MAPBGA Final Test Site
Expansion from NXP-ATTJ
to ASECL

Description

NXP Semiconductors is announcing the Final Test site expansion for the I.MXRT1050/RT1060/RT106A/RT1064 10x10 196MAPBGA associated with this notification, from the current NXP ATTJ, Tianjin, China Final Test site to the ASE, Chung-Li, Taiwan Final Test site.

Final Test site expansion was successfully qualified adhering to NXP specifications.

Please see the attached file(s) for additional details.

Reason

Qualification of ASE, Chung-Li, Taiwan is required for manufacturing flexibility and customer supply assurance.

Identification of Affected Products

Product identification does not change

Anticipated Impact on Form, Fit, Function, Reliability or Quality

No impact on form, fit, function, reliability or quality.

Disposition of Old Products

NXP will reserve the right to ship from any location based on market demand situation.

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

Name Daniel Cheng

Position Product Engineer

e-mail address jian.cheng@nxp.com

At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards.

Customer Focus, Passion to Win.

NXP Quality Management Team.

About NXP Semiconductors

NXP Semiconductors N.V. (NASDAQ: NXPI) provides High Performance Mixed Signal and Standard Product solutions that leverage its leading RF, Analog, Power Management, Interface, Security and Digital Processing expertise. These innovations are used in a wide range of automotive, identification, wireless infrastructure, lighting, industrial, mobile, consumer and computing applications.

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NXP Semiconductors

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Changed Orderable Part#	Changed Part 12NC	Changed Part Number	Changed Part Description	Package Outline	Package Name	Status	Product Line
MIMXRT106LDVL6A	935389818557	MIMXRT106LDVL6A	I.MXRT106L, 196MAPBGA	SOT1546-2	LFBGA196	RFS	Solutions
MIMXRT1064CVL5A	935377468557	MIMXRT1064CVL5A	i.MXRT1064	SOT1546-2	LFBGA196	RFS	MCUs
MIMXRT1064DVL6A	935377469557	MIMXRT1064DVL6A	i.MXRT1064	SOT1546-2	LFBGA196	RFS	MCUs
MIMXRT106FDVL6A	935389817557	MIMXRT106FDVL6A	I.MXRT106F, 196MAPBGA	SOT1546-2	LFBGA196	RFS	Solutions